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NATURE OF CONVEYANCE:	ASSIGNMENT

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Name	Execution Date
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Yoshitaka AOKI	11/27/2008

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12340084

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PATENT REEL: 022031 FRAME: 0105

BIRCH, STEWART, KOLASCH & BIRCH, LLP

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ASSIGNMENT

	Application No. 12/340,08	.4	Filed 12/19/08	
Insert Name(s) of Inventor(s)	***(Given Name FAMILY NAME (ALL CAPS))***			
	WHEREAS, Hidehiko	TANAKA	; Yoshitaka AOKI	
		<u> </u>	;	
				
	(hereinafter designated as the under	signed) has (have) invented certain r	new and useful improvements in	
Insert Title of Invention Method of Producing		Silicon Carbide		
	for which an application for Letters undersigned (except in the case of a	Patent of the United States of Ame provisional application).	crica has been executed by the	
Insert Date of Siguing of Application	on November 27, 200	8	; and	
Insert Name	Notiona	1 Inchibute for Materia	4-1- O-4 1	
of Assignee		1 Institute for Mater su Chemical Co., Ltd.	ials Science and	
Insert Address of Assignee			i-ken, Japan; and	
	its heirs, successors, legal represent desirous of acquiring the entire rig Letters Patent(s) that may be granted	ntatives and assigns (hereinafter di tht, title and interest in and to said	esignated as the Assignee) is I invention and in and to any	
CHECK BOX IF APPROPRIATE	in any foreign countries.			
	NOW, THEREFORE, in considerati paid, the receipt of which is hereby undersigned has (have) sold, assig transfer unto said Assignee the ful America, its territories, dependenciany and all Letters Patent(s) which territories, dependencies and posses countries;	y acknowledged, and other good as ned and transferred, and by these I and exclusive right to the said investigations and possessions and the entire right in may be granted therefor in the	nd valuable consideration, the presents does sell, assign and vention in the United States of ght, title and interest in and to United States of America, its	
	and to any and all divisions, reissu	es, continuations, conversions and	extensions thereof for the full	

term or terms for which the same may be granted.

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The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date November 27, 2008,	Name of Inventor	(signature) Hidehiko TANAKA
Date November 27, 2008,	Name of Inventor	Yoshiraka AOKI (signature) Yoshitaka AOKI
Date,		(signature)

June 2002

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